

L6388

HIGH-VOLTAGE HIGH AND LOW SIDE DRIVER

FEATURES 1

- HIGH VOLTAGE RAIL UP TO 600 V
- dV/dt IMMUNITY ± 50 V/nsec IN FULL **TEMPERATURE RANGE**
- DRIVER CURRENT CAPABILITY:400 mA SOURCE,650 mA SINK
- SWITCHING TIMES 70/40 nsec RISE/FALL WITH 1nF LOAD
- 3.3V, 5V, 15V CMOS/TTL INPUTS COMPARATORS WITH HYSTERESYS AND PULL DOWN
- INTERNAL BOOTSTRAP DIODE
- OUTPUTS IN PHASE WITH INPUTS
- DEAD TIME AND INTERLOCKING FUNCTION

DESCRIPTION 2

The L6388 is an high-voltage device, manufactured with the BCD"OFF-LINE" technology.

Figure 1. Package



Table 1. Order Codes

Part Number	Package
L6388	DIP8
L6388D	SDE
L6388D013TR	SO8 in Tabe & Reel

It has a Driver structure it at enables to drive independent referencec N CLannel Power MOS or IG-BT. The Upper (Floating) Section is enabled to work with vol. u.e. Rail up to 600V.

The Logic inputs are CMOS/TTL compatible for ease of interfacing with controlling devices.



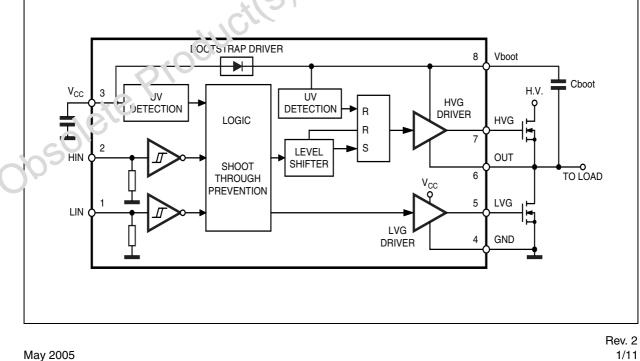


Table 2. Absolute Maximum Rating

Symbol	Parameter	Value	Unit
Vout	Output Voltage	-3 to V _{boot} - 18	V
V _{cc}	Supply Voltage	- 0.3 to +18	V
V _{boot}	Floating Supply Voltage	- 1 to 618	V
V _{hvg}	High Side Gate Output Voltage	- 1 to V _{boot}	V
V _{lvg}	Low Side Gate Output Voltage	-0.3 to V _{cc} +0.3	V
Vi	Logic Input Voltage	-0.3 to V _{cc} +0.3	V
dV _{out} /dt	Allowed Output Slew Rate	50	V/ns
P _{tot}	Total Power Dissipation ($T_j = 85^{\circ}C$)	750	mW
Тj	Junction Temperature	150	°C
T _{stg}	Storage Temperature	-50 to 150	°C

Note: ESD immunity for pins 6, 7 and 8 is guaranteed up to 900V (Human Body Model)

Figure 3. Pin Connection (Top view)

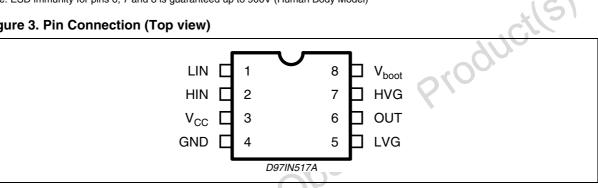


Table 3. Pin Description

N.	Name	Туре	Function	
1	LIN	I.	Low Side Driver Logic Input	
2	HIN	-	High Side Driver Logic Input	
3	Vcc	3	Low Voltage Power Supply	
4	GND		Ground	
5	LVG (*)	0	Low Side Driver Output	
6	OUT	0	High Side Driver Floating Reference	
7	HVG (*)	0	High Side Driver Output	
8	Vboot		Bootstrap Supply Voltage	

(*) The circuit guarantees 0.3V maximum on the pin (@ Isink = 10mA). This allows to omit the "bleeder" resistor connected between the gate and the source of the external MOSFET normally used to hold the pin low.

Table 4. Thermal Data

Symbo	Parameter	SO8	Minidip	Unit
R _{th j-amb}	Thermal Resistance Junction to Ambient	150	100	°C/W

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Symbol	Pin	Parameter	Test Condition	Min.	Тур.	Max.	Unit
V _{out}	6	Output Voltage		Note 1		580	V
V _{BS} (*)	8	Floating Supply Voltage		Note 1		17	V
f _{sw}		Switching Frequency	HVG,LVG load CL = 1nF			400	kHz
V _{cc}	3	Supply Voltage				17	V
Тj		Junction Temperature		-45		125	°C

Note 1: If the condition Vboot - Vout < 18V is guaranteed, Vout can range from -3 to 580V (*): V_{BS} = Vboot - Vout

Table 6. Electrical Characteristics

 $(V_{cc} = 15V; T_j = 25^{\circ}C)$

Symbol	Pin	Parameter	Test Condition	Min.	Тур.	Max.	Unit
AC OPE	AC OPERATION					5)	
t _{on}	1 vs 5 2 vs 7	High/Low Side Driver Turn-On Propagation Delay	V _{out} = 0V		225	300	ns
t _{off}		High/Low Side Driver Turn-Off Propagation Delay	V _{out} = 0V	~	160	220	ns
tr	7,5	Rise Time	C _L = 1000pF	<u>Y</u> '	70	100	ns
t _f	7,5	Fall Time	C _L = 1000pF		40	80	ns
DT	7,5	Dead Time		220	320	420	ns
DC OPE	DC OPERATION						
Low Supply Voltage Section							

oly Volt	age Section					
3	V _{cc} UV Turn On Threshold	1	9.1	9.6	10.1	V
	V _{cc} UV Turn Off Threshold		7.9	8.3	8.8	V
	V _{cc} UV Hysteresis		0.9			V
	Undervoltage Quiescent Supply Current	$V_{cc} \le 9V$		250	330	μA
	Quiescent Current	V _{cc} = 15V		350	450	μA
<u>x</u> (Bootstrap Driver on Resistance (**)	V _{cc}		125		Ω
oped Su	upply Voltage Section	•				
8	V _{BS} UV Turn On Threshold		8.5	9.5	10.5	V
	V _{BS} UV Turn Off Threshold		7.2	8.2	9.2	V
	V _{BS} UV Hysteresis		0.9			V
	V _{BS} Quiescent Current	HVG ON			250	μA
	High Voltage Leakage Current	$V_{hvg} = V_{out} = V_{boot} = 600V$			10	μA
Side D	river					
5,7	Source Short Circuit Current	$V_{IN} = V_{ih} (tp < 10 \mu s)$	300	400		mA
	Sink Short Circuit Current	$V_{IN} = V_{il} (tp < 10 \mu s)$	500	650		mA
	3 oped St 8 Side D	V _{cc} UV Turn Off Threshold V _{cc} UV Hysteresis Undervoltage Quiescent Supply Current Quiescent Current Bootstrap Driver on Resistance (**) oped Supply Voltage Section 8 V _{BS} UV Turn On Threshold V _{BS} UV Turn Off Threshold V _{BS} Quiescent Current High Voltage Leakage Current 5,7 Source Short Circuit Current	3 V_{cc} UV Turn On Threshold V_{cc} UV Turn Off Threshold V_{cc} UV Hysteresis Undervoltage Quiescent Supply Quiescent Current Quiescent Current V_{cc} = 15V Bootstrap Driver on Resistance (**) V _{cc} Supply Voltage Section 8 V _{BS} UV Turn On Threshold V _{BS} UV Turn On Threshold V _{BS} UV Turn Off Threshold V _{BS} Quiescent Current HVG ON High Voltage Leakage Current V _{hvg} = V _{out} = V _{boot} = 600V	3 V_{cc} UV Turn On Threshold9.1 V_{cc} UV Turn Off Threshold7.9 V_{cc} UV Hysteresis0.9Undervoltage Quiescent Supply Current $V_{cc} \le 9V$ Quiescent Current $V_{cc} = 15V$ Bootstrap Driver on Resistance (**) V_{cc} boped Supply Voltage Section 8.5 V_{BS} UV Turn On Threshold7.2 V_{BS} UV Turn Off Threshold7.2 V_{BS} UV Turn Off Threshold7.2 V_{BS} Quiescent CurrentHVG ONHigh Voltage Leakage Current $V_{hvg} = V_{out} = V_{boot} = 600V$ 5.7Source Short Circuit Current $V_{IN} = V_{ih}$ (tp < 10µs)	3 V_{cc} UV Turn On Threshold9.19.6 V_{cc} UV Turn Off Threshold7.98.3 V_{cc} UV Hysteresis0.9Undervoltage Quiescent Supply Current $V_{cc} \leq 9V$ 250Quiescent Current $V_{cc} = 15V$ 350Bootstrap Driver on Resistance (**) V_{cc} 125Open Supply Voltage Section8 V_{BS} UV Turn On Threshold8.59.5 V_{BS} UV Turn On Threshold7.28.2 V_{BS} UV Turn Off Threshold7.28.2 V_{BS} UV Hysteresis0.9125VBS UV Hysteresis0.9125Side Driver1401005,7Source Short Circuit Current $V_{IN} = V_{ih}$ (tp < 10µs)	3 V_{cc} UV Turn On Threshold9.19.610.1 V_{cc} UV Turn Off Threshold7.98.38.8 V_{cc} UV Hysteresis0.9Undervoltage Quiescent Supply Current $V_{cc} \le 9V$ 250330Quiescent Current $V_{cc} = 15V$ 350450Bootstrap Driver on Resistance (**) V_{cc} 125 oped Supply Voltage Section 8.59.510.5 V_{BS} UV Turn On Threshold7.28.29.2 V_{BS} UV Turn Off Threshold7.28.29.2 V_{BS} UV Turn Off Threshold7.28.29.2 V_{BS} Quiescent CurrentHVG ON25010High Voltage Leakage CurrentVhvg = V_{out} = V_{boot} = 600V10Side Driver5.7Source Short Circuit Current $V_{IN} = V_{ih}$ (tp < 10µs)

Table 6. Electrical Characteristics (continued)

 $(V_{cc} = 15V; T_j = 25^{\circ}C)$

Symbol	Pin	Parameter	Test Condition	Min.	Тур.	Max.	Unit
Logic Inp	Logic Inputs						
V _{il}	1, 2	Low Level Logic Input Voltage				1.1	V
V _{ih}		High Level Logic Input Voltage		1.8			V
l _{ih}		High Level Logic Input Current	V _{IN} = 15V		20	70	μA
lii		Low Level Logic Input Current	$V_{IN} = 0V$	-1			μA

(**) RDSON is tested in the following way: $R_{DSON} = \frac{(V_{CC} - V_{CBOOT1}) - (V_{CC} - V_{CBOOT2})}{I_1(V_{CC}, V_{CCBOOT1}) - I_2(V_{CC}, V_{CCBOOT2})}$ where I₁ is pin 8 current when V_{CBOOT} = V_{CBOOT1}, I2 when V_{CBOOT} = V_{CBOOT2}.

Figure 4. Dead Time Waveforms Definitions

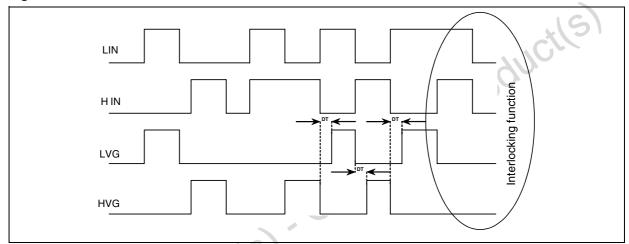
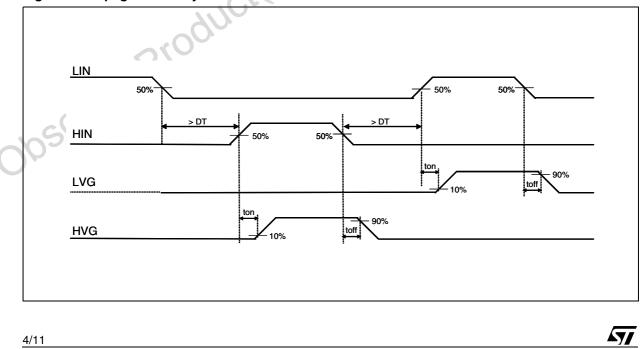


Figure 5. Propagation Delay Waveform Definitions



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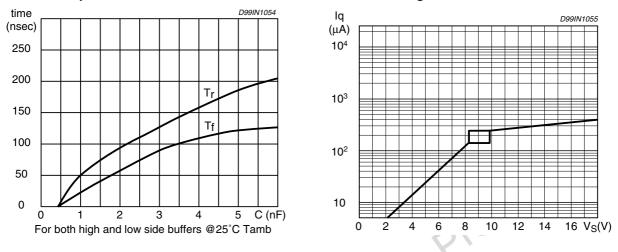
3 INPUT LOGIC

Input logic is provided with an interlocking circuitry which avoids the two outputs (LVG, HVG) to be active at the same time when both the logic input pins (LIN, HIN) are at a high logic level. In addition, to prevent cross conduction of the external MOSFETs, after each output is turned-off the other output cannot be turned-on before a certain amount of time (DT) (see Figure 4).

Figure 7. Quiescent Current vs. Supply

Voltage

Figure 6. Typical Rise and Fall Times vs. Load Capacitance



3.1 BOOTSTRAP DRIVER

A bootstrap circuitry is needed to supply the high voltage section. This function is normally accomplished by a high voltage fast recovery diode (fig. 8a). In the L6388 a patented integrated structure replaces the external diode. It is realized by a high voltage DMOS, driven synchronously with the low side driver (LVG), with in series a diode, as shown in fig. 8b

An internal charge pump (fig. 8b) provides the DMOS driving voltage .

The diode connected in series to the DMOS has been added to avoid undesirable turn on of it.

3.2 CBOOT selection and charging

To choose the proper C_{BOOT} value the external MOS can be seen as an equivalent capacitor. This capacitor C_{EXT} is related to the MOS total gate charge :

$$C_{EXT} = \frac{Q_{gate}}{V_{gate}}$$

The ratio between the capacitors C_{EXT} and C_{BOOT} is proportional to the cyclical voltage loss . It has to be:

e.g.: if Q_{gate} is 30nC and V_{gate} is 10V, C_{EXT} is 3nF. With $C_{BOOT} = 100$ nF the drop would be 300mV.

If HVG has to be supplied for a long time, the CBOOT selection has to take into account also the leakage losses.

e.g.: HVG steady state consumption is lower than 200 μ A, so if HVG T_{ON} is 5ms, CBOOT has to supply 1 μ C to C_{EXT}. This charge on a 1 μ F capacitor means a voltage drop of 1V.

The internal bootstrap driver gives great advantages: the external fast recovery diode can be avoided (it usually has great leakage current). This structure can work only if V_{OUT} is close to GND (or lower) and in the meanwhile the LVG is on. The charging time (T_{charge}) of the C_{BOOT} is the time in which both conditions are fulfilled and it

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has to be long enough to charge the capacitor.

The bootstrap driver introduces a voltage drop due to the DMOS RDSON (typical value: 125 Ohm). At low frequency this drop can be neglected. Anyway increasing the frequency it must be taken in to account.

The following equation is useful to compute the drop on the bootstrap DMOS:

$$V_{drop} = I_{charge}R_{dson} \rightarrow V_{drop} = \frac{Q_{gate}}{T_{charge}}R_{dson}$$

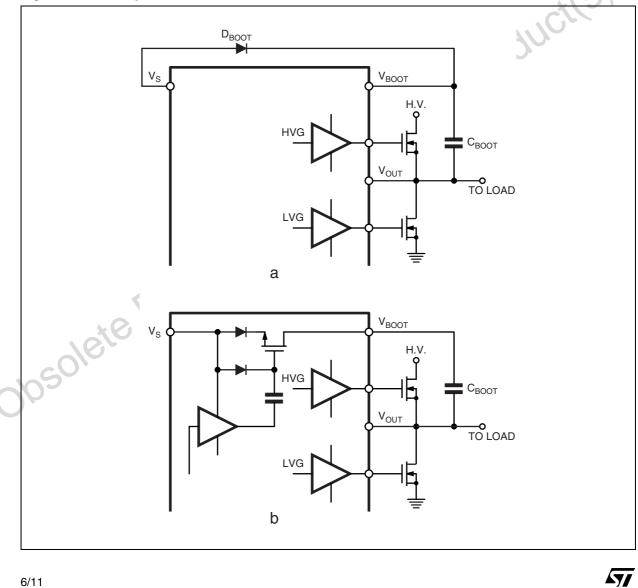
where Q_{gate} is the gate charge of the external power MOS, R_{dson} is the on resistance of the bootstrap DMOS, and T_{charge} is the charging time of the bootstrap capacitor.

For example: using a power MOS with a total gate charge of 30nC the drop on the bootstrap DMOS is about 1V, if the T_{charge} is 5μ s. In fact:

$$V_{drop} = \frac{30nC}{5\mu s} \cdot 125\Omega \sim 0.8V$$

 V_{drop} has to be taken into account when the voltage drop on C_{BOOT} is calculated: if this drop is too high, or the circuit topology doesn't allow a sufficient charging time, an external diode can be used.

Figure 8. Bootstrap Driver.

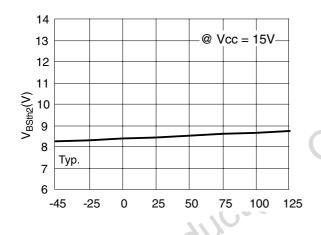


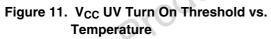
13 @ Vcc = 15V 12 11 Тур. 10 V_{BSth1}(V) 9 8 7 6 5 -45 -25 0 25 50 75 100 125 Tj (°C)

Figure 9. V_{BOOT} UV Turn On Threshold vs.

Temperature

Figure 10. V_{BOOT} UV Turn Off Threshold vs. Temperature





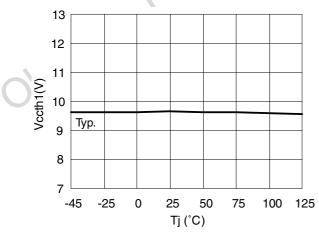
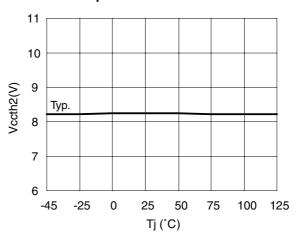
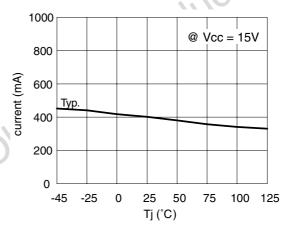
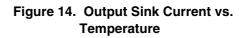


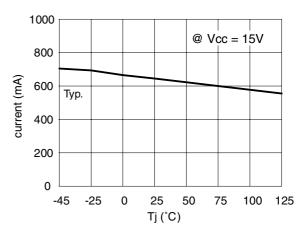
Figure 12. V_{CC} UV Turn Off Threshold vs. Temperature











L6388

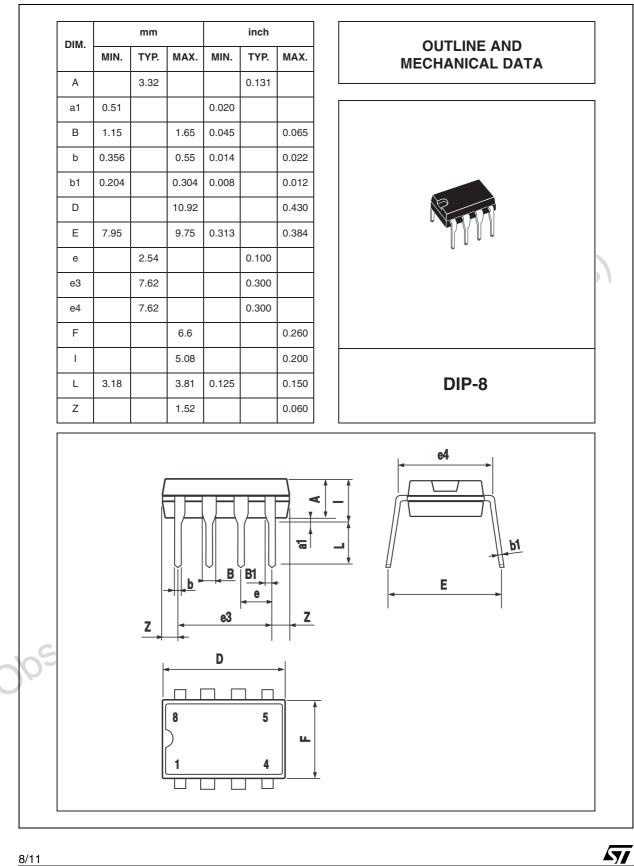


Figure 15. DIP8 Mechanical Data & Package Dimensions

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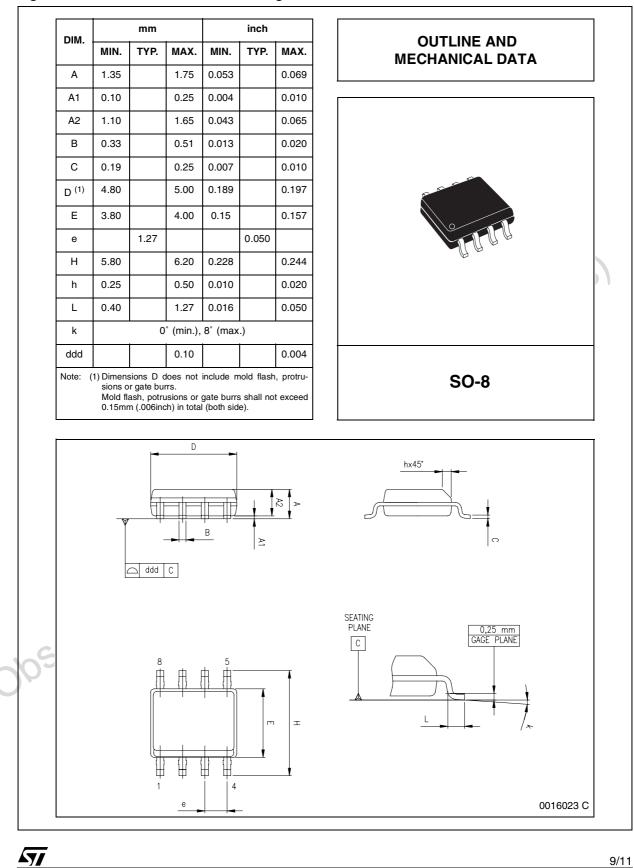


Figure 16. SO8 Mechanical Data & Package Dimensions

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Table 7. Revision History

Date	Revision	Description of Changes
January 2005	1	First Issue
May 2005	2	Changed from Preliminary Data to Final

Obsolete Product(s) - Obsolete Product(s)

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